



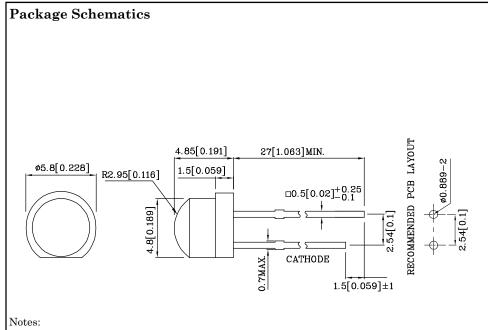
5mm ROUND LED LAMP

# **Features**

- Radial / Through hole package
- $\bullet$  Reliable & robust
- Low power consumption
- Available on tape and reel
- RoHS Compliant







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		M2ACR (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current	$I_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	$P_D$	84	mW	
Operating Temperature	$T_{A}$ -40 ~ +85		°C	
Storage Temperature	Tstg	-40 ~ +85	C	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds			
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds			

Operating Characteristics $(T_A=25^{\circ}C)$		M2ACR (AlGaInP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.8	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λΡ	640*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=20\text{mA})$	λD	625*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	25	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	27	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		Wavelength CIE127-2007* nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XLM2ACR169W	Red	AlGaInP	Water Clear	700 400*	995 695*	640*	130°

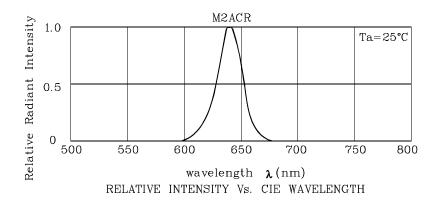
<sup>\*</sup>Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

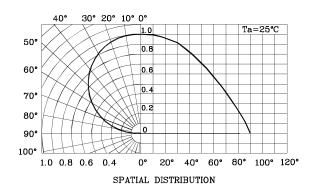
Mar 25,2014



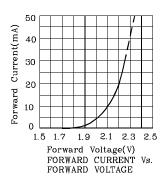
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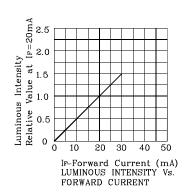


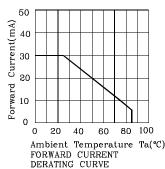


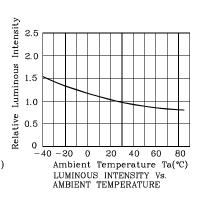


# **❖** M2ACR

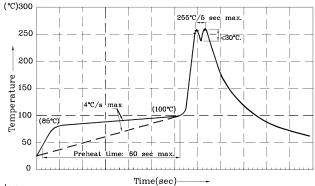








Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



Notes: Notes. I. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of  $260^{\circ}C$  2. Peak wave soldering temperature between  $245^{\circ}C \sim 255^{\circ}C$  for 3 sec

(5 sec max).

3.Do not apply stress to the epoxy resin while the temperature is above  $85\,^\circ\text{C}.$  4.Fixtures should not incur stress on the component when mounting and

during soldering process. 5.SAC 305 solder alloy is recommended.

6. No more than one wave soldering pass.

### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous Intensity / Luminous Flux: +/-15%

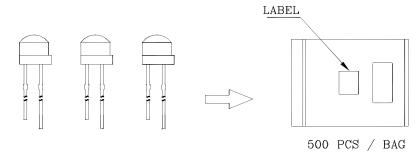
3. Forward Voltage: +/-0.1V

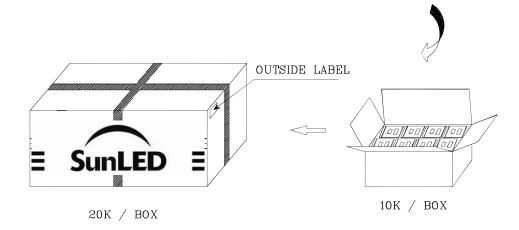
Note: Accuracy may depend on the sorting parameters.

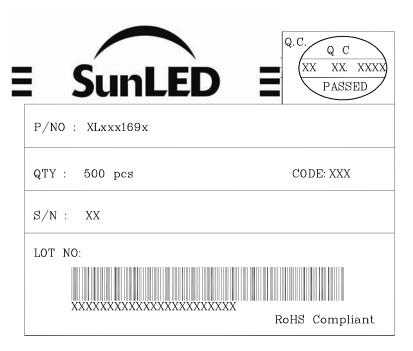


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# PACKING & LABEL SPECIFICATIONS







# TERMS OF USE

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